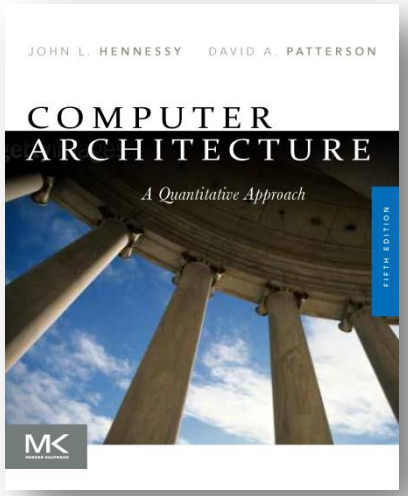

Chapter 1

Fundamentals of Quantitative Design and Analysis

Adapted by Prof. Gheith Abandah

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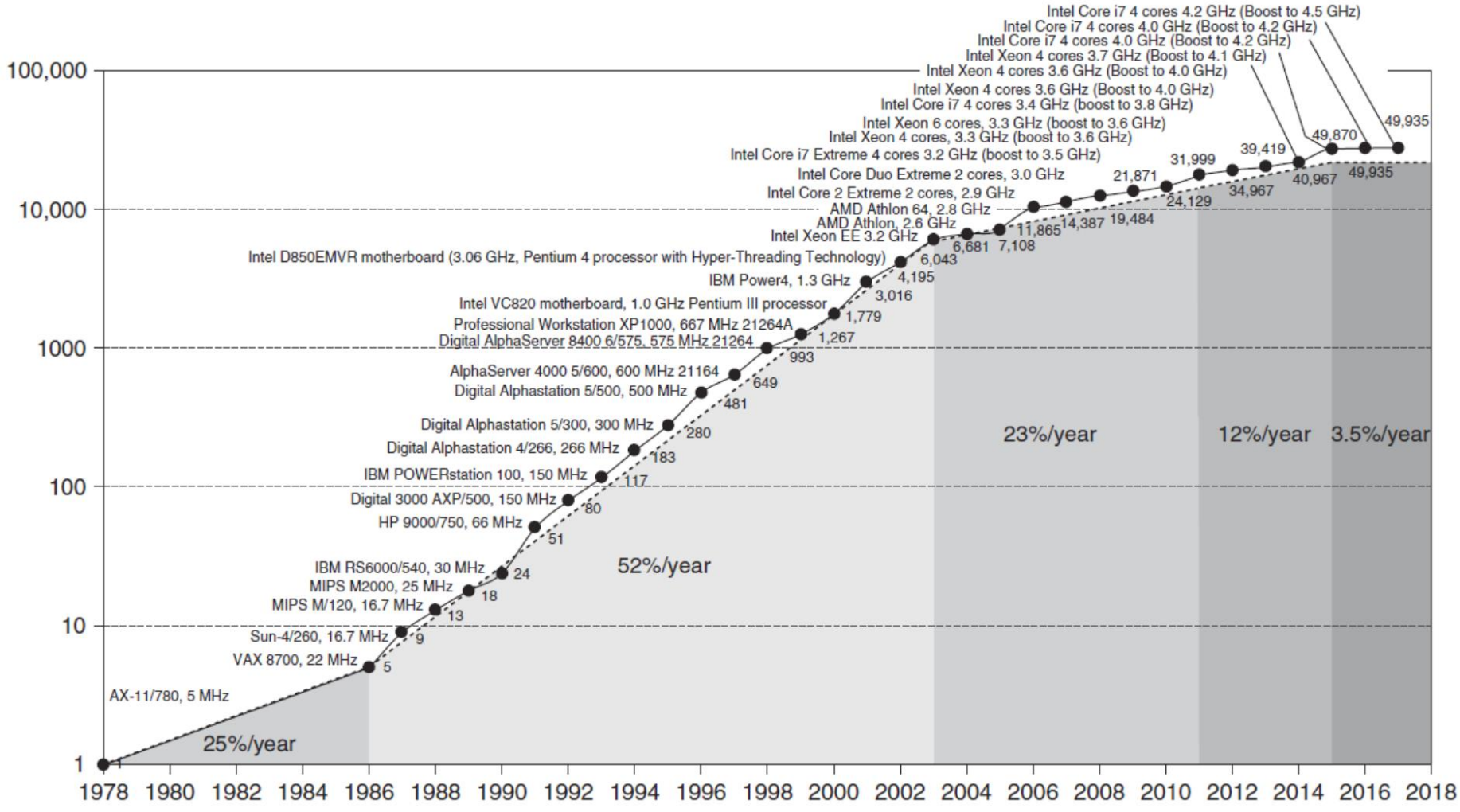
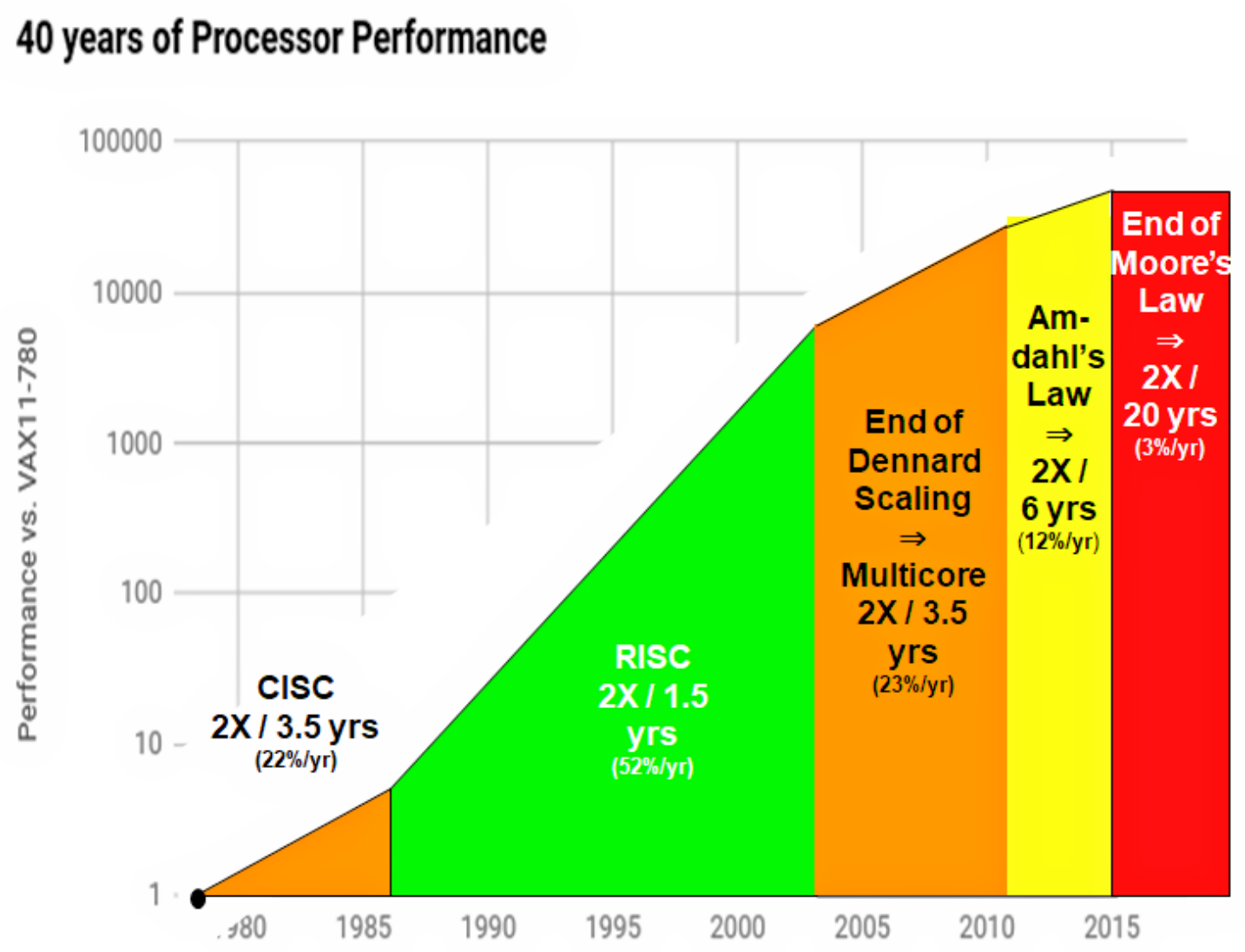
Computer Technology

- Performance improvements:
  - Improvements in semiconductor technology
    - Feature size, clock speed
  - Improvements in computer architectures
    - Enabled by HLL compilers, UNIX
    - Lead to RISC architectures
  - Together have enabled:
    - Lightweight computers
    - Productivity-based managed/interpreted programming languages

Single Processor Performance



Single Processor Performance



Current Trends in Architecture

- Cannot continue to leverage instruction-level parallelism (ILP)
  - Single processor performance improvement ended in 2003
- New models for performance:
  - Data-level parallelism (DLP)
  - Thread-level parallelism (TLP)
  - Request-level parallelism (RLP)
- These require explicit restructuring of the application

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Classes of Computers

- Personal Mobile Device (PMD)
  - E.g. smart phones, tablet computers
  - Emphasis on energy efficiency and real-time
- Desktop Computing
  - Emphasis on price-performance
- Servers
  - Emphasis on availability, scalability, throughput
- Clusters / Warehouse Scale Computers
  - Used for “Software as a Service (SaaS)”
  - Emphasis on availability and price-performance
  - Sub-class: Supercomputers, emphasis: floating-point performance and fast internal networks
- Internet of Things/Embedded Computers
  - Emphasis: price

Parallelism

- Classes of parallelism in applications:
  - Data-Level Parallelism (DLP)
  - Task-Level Parallelism (TLP)
- Classes of architectural parallelism:
  - Instruction-Level Parallelism (ILP)
  - Vector architectures/Graphic Processor Units (GPUs)
  - Thread-Level Parallelism
  - Request-Level Parallelism

Flynn's Taxonomy

- Single instruction stream, single data stream (SISD)
- Single instruction stream, multiple data streams (SIMD)
  - Vector architectures
  - Multimedia extensions
  - Graphics processor units
- Multiple instruction streams, single data stream (MISD)
  - No commercial implementation
- Multiple instruction streams, multiple data streams (MIMD)
  - Tightly-coupled MIMD
  - Loosely-coupled MIMD

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Defining Computer Architecture

- "Old" view of computer architecture:
  - Instruction Set Architecture (ISA) design
  - i.e. decisions regarding:
    - registers, memory addressing, addressing modes, instruction operands, available operations, control flow instructions, instruction encoding
- "Real" computer architecture:
  - Specific requirements of the target machine
  - Design to maximize performance within constraints: cost, power, and availability
  - Includes ISA, microarchitecture, hardware

Instruction Set Architecture

- Class of ISA
  - General-purpose registers
  - Register-memory vs load-store
- RISC-V registers
  - 32 g.p., 32 f.p.

Register	Name	Use	Saver
x0	zero	constant 0	n/a
x1	ra	return addr	caller
x2	sp	stack ptr	callee
x3	gp	gbl ptr	
x4	tp	thread ptr	
x5-x7	t0-t2	temporaries	caller
x8	s0/fp	saved/ frame ptr	callee
x9	s1	saved	callee
x10-x17	a0-a7	arguments	caller
x18-x27	s2-s11	saved	callee
x28-x31	t3-t6	temporaries	caller
f0-f7	ft0-ft7	FP temps	caller
f8-f9	fs0-fs1	FP saved	callee
f10-f17	fa0-fa7	FP arguments	callee
f18-f27	fs2-fs21	FP saved	callee
f28-f31	ft8-ft11	FP temps	caller

RISC-V ISA

- Memory addressing
  - byte addressed, aligned accesses faster
- Addressing modes
  - Register, immediate, displacement (base+offset)
- Types and size of operands
  - 8-bit, 32-bit, 64-bit

RISC-V ISA

- Operations
  - Data transfer — `ld x5,0(x6)`
  - Arithmetic — `add x5,x6,x7`
  - Logical — `add x5,x6,x7`
  - Floating point — `fadd.d f5,f6,f7`
- Control flow instructions
  - Use content of registers — `beq x5,x6,Label`
  - Return address in register — `jal x1, F1`
    `jalr x0,0(x1)`
- Encoding
  - Fixed, 32 bits

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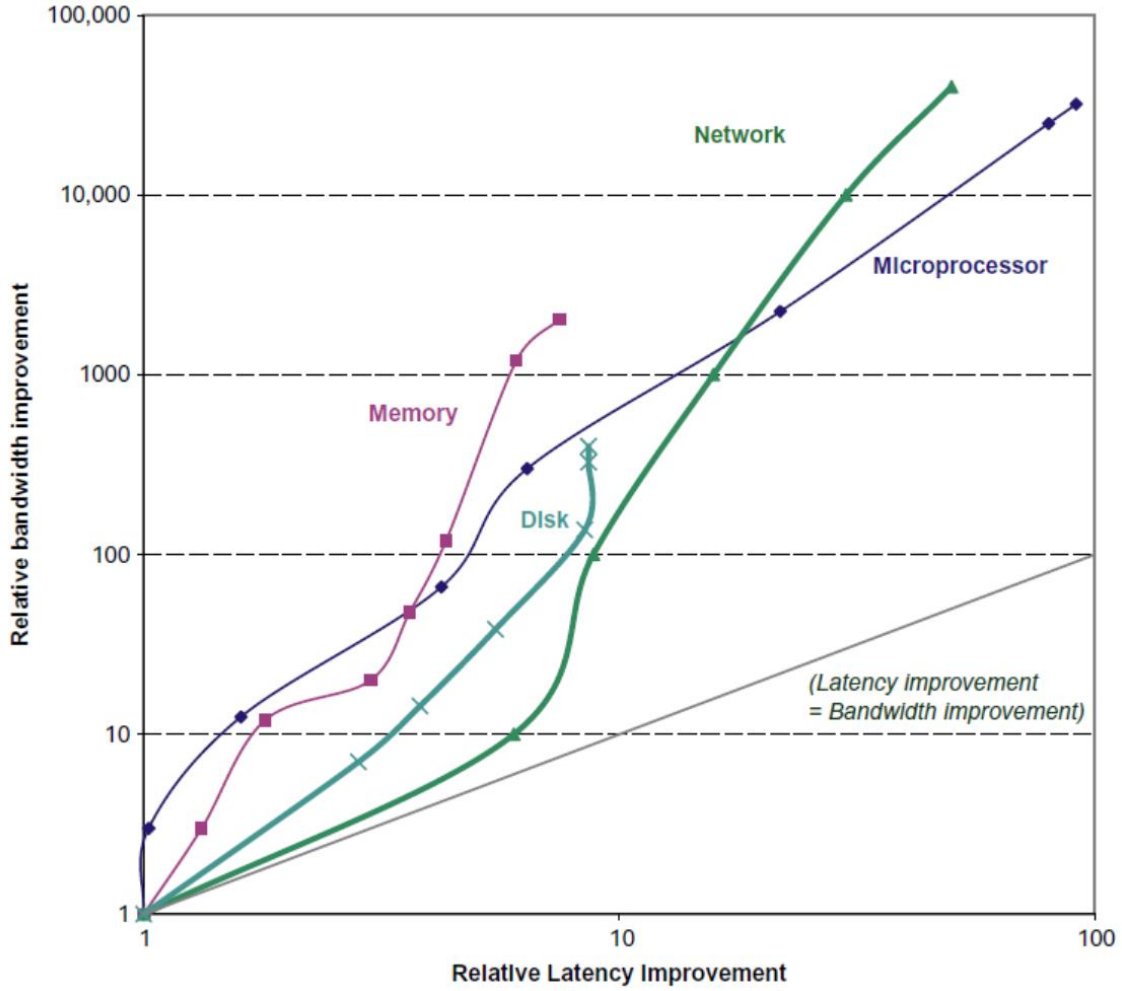
Trends in Technology

- Integrated circuit technology (Moore's Law)
  - Transistor density: 35%/year
  - Die size: 10-20%/year
  - Integration overall: 40-55%/year
- DRAM capacity: 25-40%/year (slowing)
  - 8 Gb (2014), 16 Gb (2019), possibly no 32 Gb
- Flash capacity: 50-60%/year
  - 8-10X cheaper/bit than DRAM
- Magnetic disk capacity: recently slowed to 5%/year
  - Density increases may no longer be possible, maybe increase from 7 to 9 platters
  - 8-10X cheaper/bit then Flash
  - 200-300X cheaper/bit than DRAM

Bandwidth and Latency

- For milestones in 25-40 years
- Bandwidth or throughput
  - Total work done in a given time
  - 32,000-40,000X improvement for processors
  - 300-1200X improvement for memory and disks
- Latency or response time
  - Time between start and completion of an event
  - 50-90X improvement for processors
  - 6-8X improvement for memory and disks

Bandwidth and Latency



Log-log plot of bandwidth and latency milestones

Transistors and Wires

- Feature size
  - Minimum size of transistor or wire in x or y dimension
  - 10 microns in 1971 to .011 microns (11 nm) in 2017
  - Transistor performance scales linearly
    - Wire delay does not improve with feature size!
  - Integration density scales quadratically

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Power and Energy

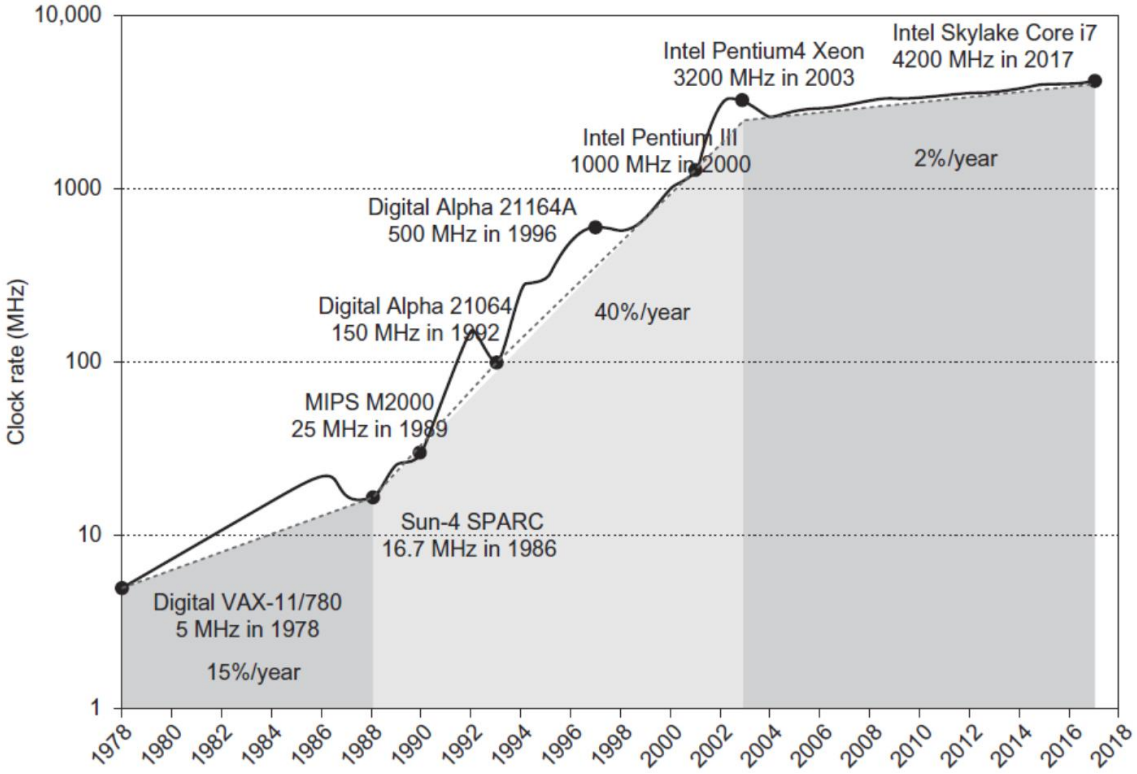
- Problem: Get power in, get power out
- Thermal Design Power (TDP)
  - Characterizes sustained power consumption
  - Used as target for power supply and cooling system
  - Lower than peak power (1.5X higher), higher than average power consumption
- Clock rate can be reduced dynamically to limit power consumption
- Energy per task is often a better measurement

Dynamic Energy and Power

- Dynamic energy
  - Transistor switch from 0 -> 1 or 1 -> 0
  - ½ x Capacitive load x Voltage^2
- Dynamic power
  - ½ x Capacitive load x Voltage^2 x Frequency switched
- Reducing clock rate reduces power, not energy

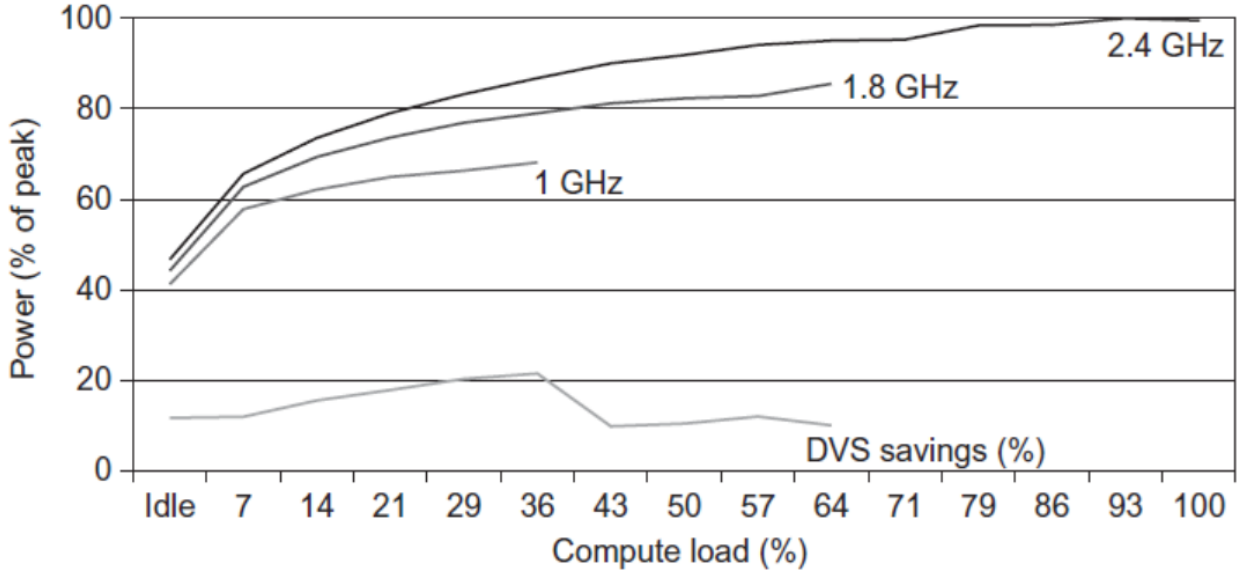
Power

- Intel 80386 consumed ~ 2 W
- 3.3 GHz Intel Core i7 consumes 130 W
- Heat must be dissipated from 1.5 x 1.5 cm chip
- This is the limit of what can be cooled by air



Reducing Power

- Techniques for reducing power:
  - Do nothing well (turn clock off)
  - Dynamic Voltage-Frequency Scaling

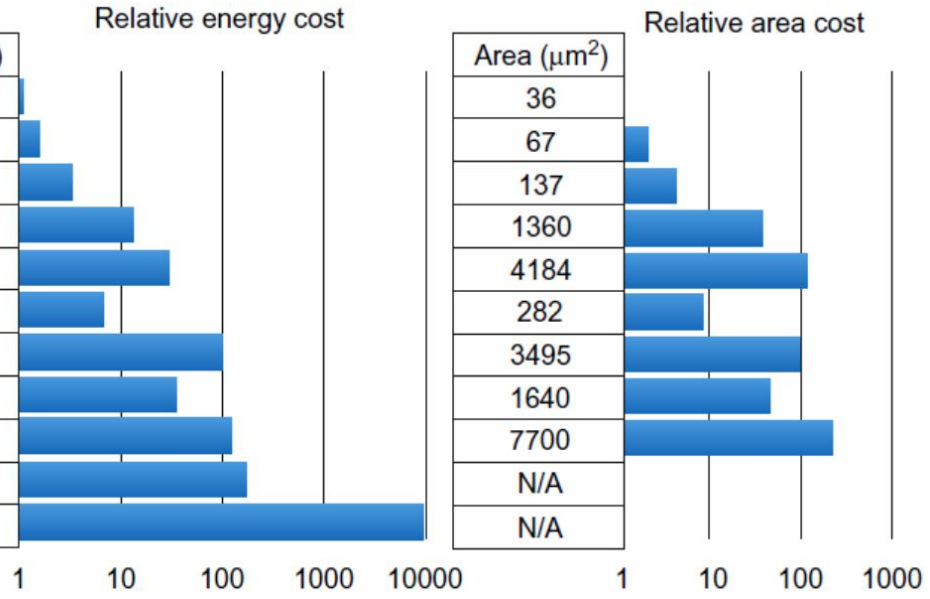


  - Low power state for DRAM, disks
  - Overclocking, turning off cores

Static Power

- Static power consumption
  - 25-50% of total power
  - $Current_{static}$ x Voltage
  - Scales with number of transistors
  - To reduce: power gating
- Energy and die area motivate domain-specific architectures.

Operation:	Energy (pJ)	Area (μm^2)
8b Add	0.03	36
16b Add	0.05	67
32b Add	0.1	137
16b FB Add	0.4	1360
32b FB Add	0.9	4184
8b Mult	0.2	282
32b Mult	3.1	3495
16b FB Mult	1.1	1640
32b FB Mult	3.7	7700
32b SRAM Read (8KB)	5	N/A
32b DRAM Read	640	N/A



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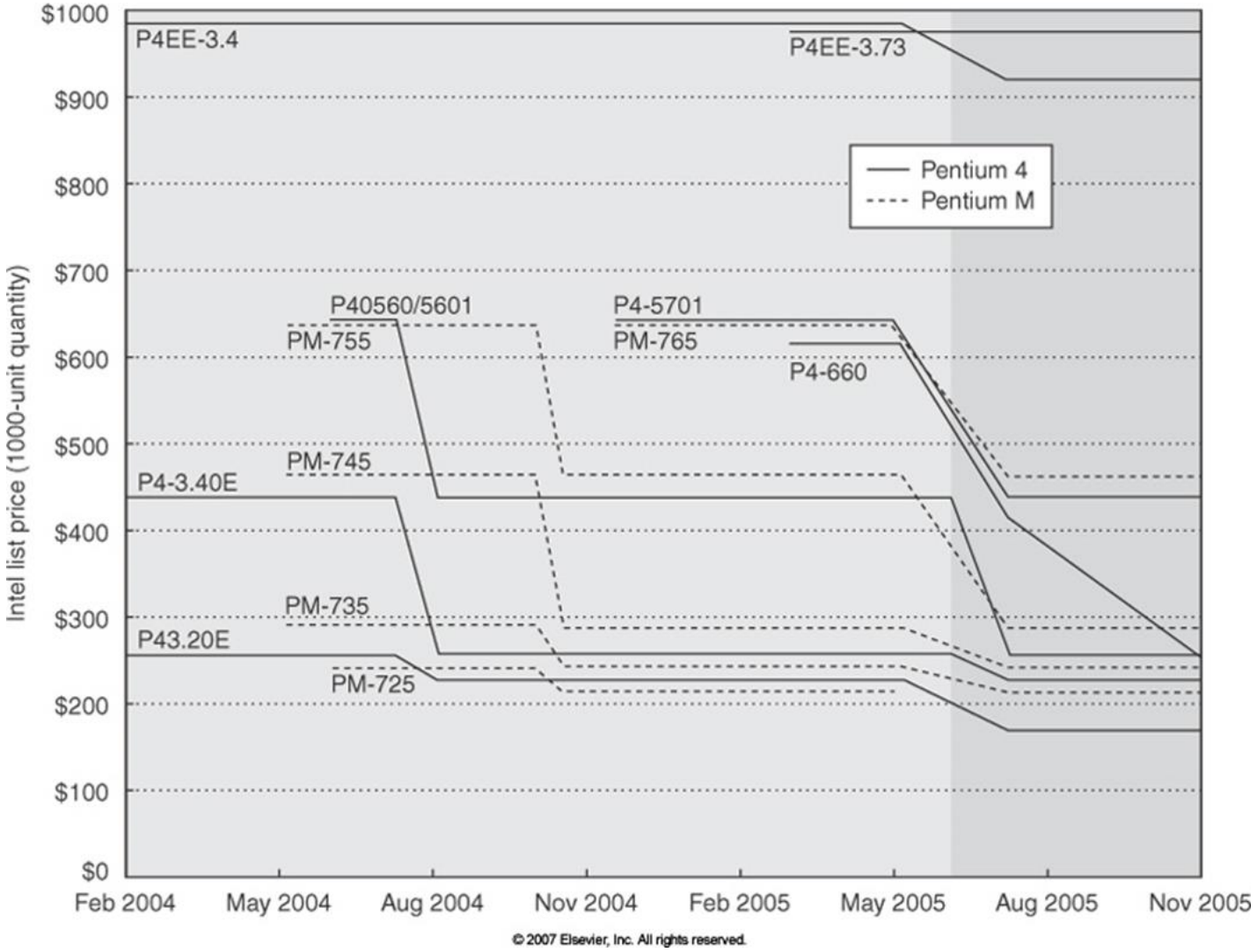
Trends in Cost

- Cost driven down by learning curve
  - Yield
- DRAM: price closely tracks cost
- Microprocessors: price depends on volume
  - 10% less for each doubling of volume

Cost over Time



Integrated Circuit Cost

$$Cost\ of\ integrated\ circuit = \frac{Cost\ of\ die + Cost\ of\ testing\ die + Cost\ of\ packaging\ and\ final\ test}{Final\ test\ yield}$$

$$Cost\ of\ die = \frac{Cost\ of\ wafer}{Dies\ per\ wafer\ x\ Die\ yield}$$

$$Dies\ per\ wafer = \frac{\pi \times (Wafer\ diameter/2)^2}{Die\ area} - \frac{\pi \times Wafer\ diameter}{\sqrt{2 \times Die\ area}}$$

- Bose-Einstein formula:

$$Die\ yield = Wafer\ yield \times 1/(1 + Defects\ per\ unit\ area \times Die\ area)^N$$

- Defects per unit area = 0.016-0.057 defects per square cm (2010)
- N = process-complexity factor = 11.5-15.5 (40 nm, 2010)

- IC cost α (die area)^x : $x \sim 2$

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Dependability

- Module reliability
  - Mean time to failure (MTTF)
  - Mean time to repair (MTTR)
  - Mean time between failures (MTBF) = MTTF + MTTR
  - Availability = MTTF / MTBF
- FIT = Failure in Time = 10^9 / MTTF
- Example 1: Find the system MTTF and availability for:

Component	QTY	MTTF (hrs)	MTTR (hrs)
C1	10	10^6	10
C2	1	10^5	10

Dependability

- Dependability can be improve through redundancy.
- MTTF for redundant pair =

  $(MTTF/2) / (MTTR/MTTF) = MTTF^2 / 2MTTR$
- Example 2: Solve Example 1 assuming a redundant pair.

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Measuring Performance

- Typical performance metrics:
  - Response time
  - Throughput
- Speedup of X relative to Y
  - Performance_X / Performance_Y
  - Execution time_Y / Execution time_X
- Execution time
  - Wall clock time: includes all system overheads
  - CPU time: only computation time
- Benchmarks
  - Kernels (e.g. matrix multiply)
  - Toy programs (e.g. sorting)
  - Synthetic benchmarks (e.g. Dhrystone)
  - Benchmark suites (e.g. SPEC CPU2017, TPC-C)

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Principles of Computer Design

- Take Advantage of Parallelism
  - e.g. multiple processors, disks, memory banks, pipelining, multiple functional units
- Principle of Locality
  - Reuse of data and instructions
- Focus on the Common Case
  - Amdahl's Law

$$Execution\ time_{new} = Execution\ time_{old} \times \left((1 - Fraction_{enhanced}) + \frac{Fraction_{enhanced}}{Speedup_{enhanced}} \right)$$

$$Speedup_{overall} = \frac{1}{(1 - Fraction_{enhanced}) + \frac{Fraction_{enhanced}}{Speedup_{enhanced}}}$$

Principles of Computer Design

- The Processor Performance Equation

$$CPU\ time = CPU\ clock\ cycles\ for\ a\ program \times Clock\ cycle\ time$$

$$CPU\ time = \frac{CPU\ clock\ cycles\ for\ a\ program}{Clock\ rate}$$

$$CPI = \frac{CPU\ clock\ cycles\ for\ a\ program}{Instruction\ count}$$

$$CPU\ time = Instruction\ count \times Cycles\ per\ instruction \times Clock\ cycle\ time$$

$$\frac{Instructions}{Program} \times \frac{Clock\ cycles}{Instruction} \times \frac{Seconds}{Clock\ cycle} = \frac{Seconds}{Program} = CPU\ time$$

Principles of Computer Design

- Different instruction types having different CPIs

$$CPU\ clock\ cycles = \sum_{i=1}^{n} IC_i \times CPI_i$$

$$CPU\ time = \left(\sum_{i=1}^{n} IC_i \times CPI_i \right) \times Clock\ cycle\ time$$

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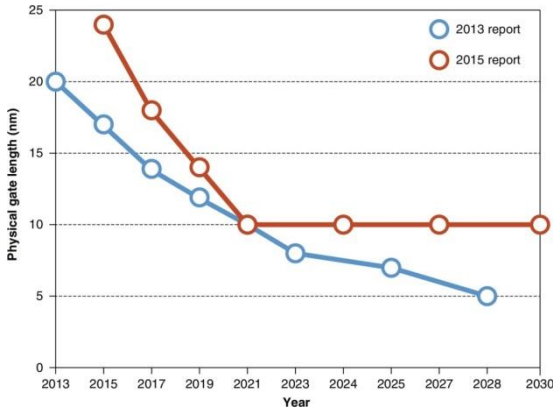
Fallacies and Pitfalls

- P: All exponential laws must come to an end
  - Dennard scaling (constant power density)
    - Stopped by threshold voltage
  - Disk capacity
    - 30-100% per year to 5% per year
  - Moore's Law
    - Most visible with DRAM capacity
    - ITRS disbanded
    - Only four foundries left producing state-of-the-art logic chips
    - 11 nm, 3 nm might be the limit



Fallacies and Pitfalls

- F: Microprocessors are a silver bullet
  - Performance is now a programmer's burden
- P: Falling prey to Amdahl's Law
- P: A single point of failure
  - The system is as strong as its weakest part.
- F: Hardware enhancements that increase performance also improve energy efficiency, or are at worst energy neutral
- F: Benchmarks remain valid indefinitely
  - Compiler optimizations target benchmarks

Fallacies and Pitfalls

- F: The rated mean time to failure of disks is 1,200,000 hours or almost 140 years, so disks practically never fail
  - MTTF value from manufacturers assume regular replacement every 5 years

- P: Fault detection can lower availability
  - Not all operations are needed for correct execution

Fallacies and Pitfalls

- F: Peak performance tracks observed performance